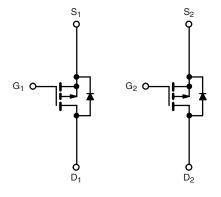


# **Dual P-Channel 20-V (D-S) MOSFET**

PRODU	PRODUCT SUMMARY			
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)	
	0.013 at V <sub>GS</sub> = - 4.5 V	-7.5		
- 20	0.018 at V <sub>GS</sub> = - 2.5 V	-6.5	20 nC	
	0.032 at V <sub>GS</sub> = - 1.8 V	-5.0		



P-Channel MOSFET

P-Channel MOSFET

#### **FEATURES**

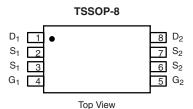
- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- · Adaptor Switch
- High Current Load Switch
- Notebook



Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12	
	T <sub>C</sub> = 25 °C		- 7.5	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	T <sub>C</sub> = 70 °C	1_	- 6.0	
Continuous Diain Current (1) = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 5.4 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		- 4.5 <sup>a, b</sup>	Α
Pulsed Drain Current		I <sub>DM</sub>	- 30	A
Ocations of Ocate Picture Ocate	T <sub>C</sub> = 25 °C		- 4.1	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>a, b</sup>	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 15	
Single-Pulse Avalanche Energy		E <sub>AS</sub>	11.25	mJ
	T <sub>C</sub> = 25 °C		5	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C		3.2	w
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	VV
	T <sub>A</sub> = 70 °C		1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stq</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	$R_{thJA}$	38	50	°C/W	
Maximum Junction-to-Foot	Steady State	$R_{th,IF}$	20	25	C/VV	

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s
- c. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}.$
- d. Based on  $T_C = 25$  °C.

服务热线:400-655-8788

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$			- 14.5		m\//9C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		2.8		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	— иА	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -5 \text{ V}$	- 20			Α	
	, ,	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7 A		0.013		1	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 6 A		0.018		Ω	
	- (- )	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 3 A		0.032			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 9 A		40		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			2380		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		340			
Reverse Transfer Capacitance	C <sub>rss</sub>			280			
Tatal Oats Observe	$Q_g = V_{DS} = -10 \text{ V}, V_{GS} = -8$	$V_{DS} = -10 \text{ V}, V_{GS} = -8 \text{ V}, I_{D} = -5 \text{ A}$		45	70	nC	
Total Gate Charge				20	35		
Gate-Source Charge		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5 A		3.1			
Gate-Drain Charge	Q <sub>ad</sub>			8.4			
Gate Resistance	R <sub>q</sub>	f = 1 MHz	1.0	4.8	9.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			7	14		
Rise Time	t <sub>r</sub>	$V_{DD} = -10 \text{ V}, R_L = 2 \Omega$ $I_D \cong -5 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$		9	18	]	
Turn-Off DelayTime	t <sub>d(off)</sub>			108	200		
Fall Time	t <sub>f</sub>	Ĭ		41	80		
Turn-On Delay Time t <sub>d(on)</sub>				14	28	ns -	
Rise Time				16	32		
Turn-Off DelayTime	t <sub>d(off)</sub>	$V_{DD} = -10 \text{ V}, R_L = 2 \Omega$ $I_D \cong -5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		101	200	1	
Fall Time	t <sub>f</sub>	j		40	80	1	
<b>Drain-Source Body Diode Characteris</b>	stics						
Continous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			- 4.1	А	
Pulse Diode Forward Current	I <sub>SM</sub>	-			- 40		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A, V <sub>GS</sub> = 0 V		- 0.66	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	3 33		81	150	ns	
ody Diode Reverse Recovery Charge O			150	300	nC		
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -2.3 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 °C$		43		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	<del> </del>		38			

#### Notes:

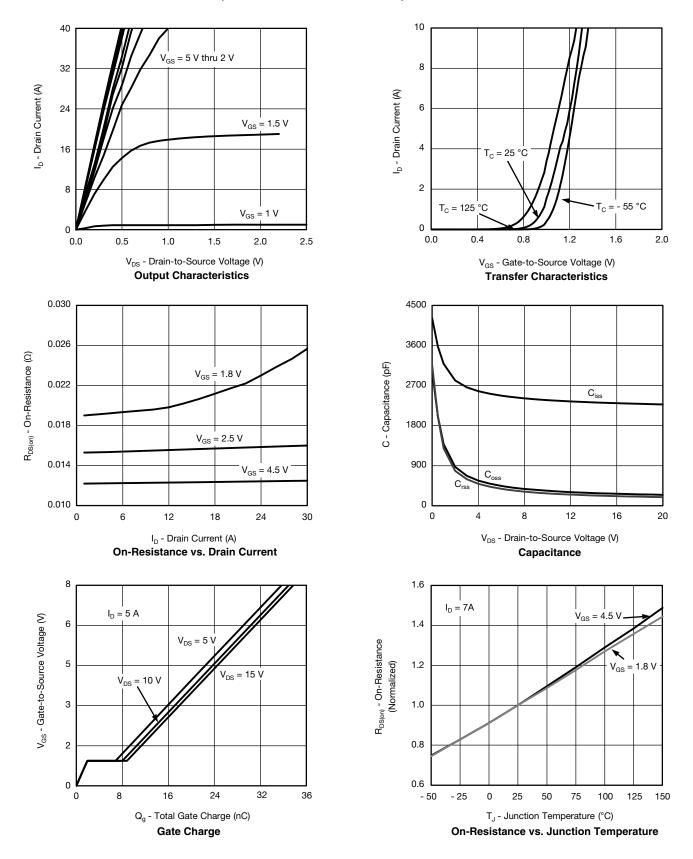
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- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



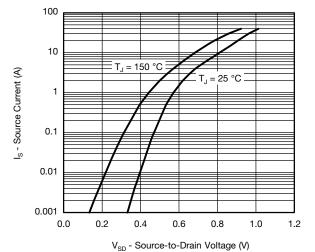
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



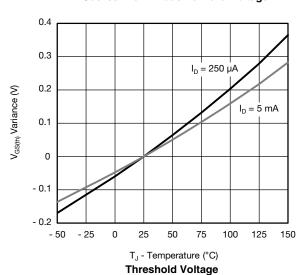
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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

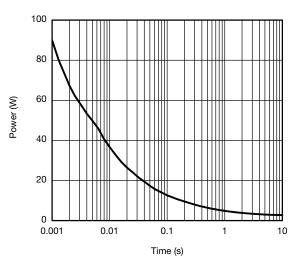


Source-Drain Diode Forward Voltage

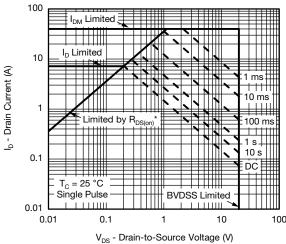


V<sub>GS</sub> - Gate-to-Source Voltage (V)

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

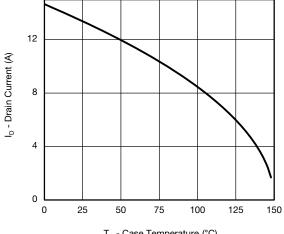


\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

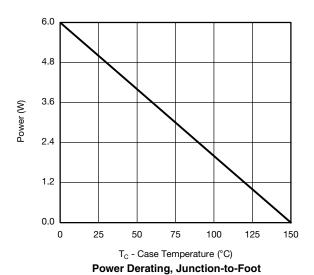
Safe Operating Area

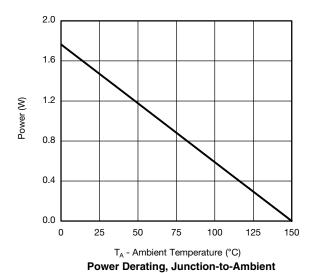


## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



T<sub>C</sub> - Case Temperature (°C) **Current Derating\*** 

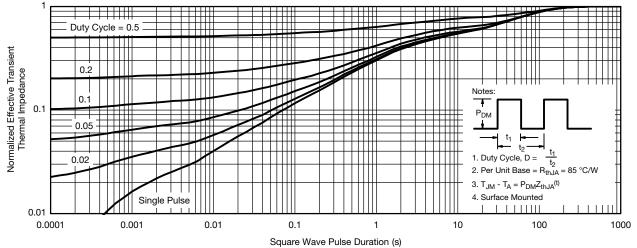




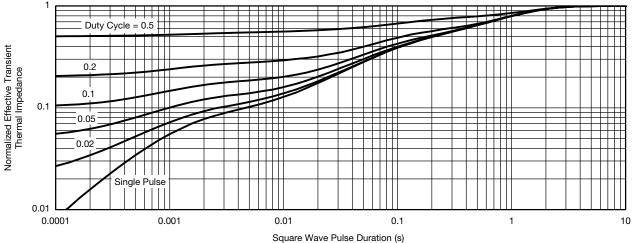
<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



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